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4-bit 1-of-2 FET Multiplexer / Demultiplexer

www.DataSheet4U.com



ADE-205-624B (Z)

Rev. 2 Nov. 2001

Description

The HD74CBT3257 is a 4-bit 1-of-2 high-speed TTL-compatible FET multiplexer / demultiplexer. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

Output enable (\overline{OE}) and select control (S) inputs select the appropriate B1 and B2 outputs for the A-input data.

Features

- Minimal propagation delay through the switch.
- 5 Ω switch connection between two ports.
- TTL-compatible input levels.
- Ultra low quiescent power. -Ideally suited for notebook applications.
- Package type

Product code example: HD74CBT3257TELL

Package type	Package code	Package suffix	Taping code		
TSSOP-16pin	TTP-16DA	Т	ELL(2000pcs / Reel)		

Notes: 1. As for the Pb-free package is attached the "V" to the end of package code.

2. As for the Pb-free product is attached the "-E" to the end of product code.

Function Table

Inputs

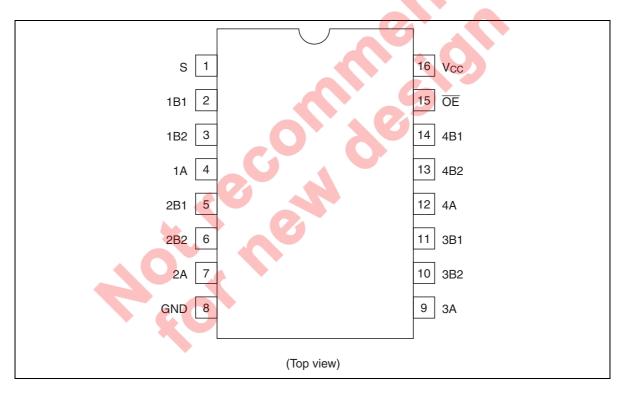
ŌĒ	www.DataSheet4U.com	S	Function
L		L	A port = B1 port
L		Н	A port = B2 port
Н		Х	Disconnect
11.	L Bada Lavial		

H: High level

L: Low level

X: Immaterial

Pin Arrangement



Absolute Maximum Ratings

em Symbol		Ratings	Unit	Conditions
Supply voltage range 4U.com	V _{cc}	-0.5 to 7.0	V	
Input voltage range ^{*1}	V	-0.5 to 7.0	V	
Input clamp current	I _{ік}	-50	mA	V ₁ < 0
Continuous output current	I _o	128	mA	$V_{o} = 0$ to V_{cc}
Continuous current through V_{cc} or GND	$I_{\rm cc} \text{ or } I_{\rm gnd}$	±100	mA	
Maximum power dissipation at Ta = 25°C (in still air) 2	P _T	500	mW	TSSOP
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

1. The input and output voltage ratings may be exceeded even if the input and output clamp-current ratings are observed.

2. The maximum package power dissipation was calculated using a junction temperature of 150°C.

Recommended Operating Conditions

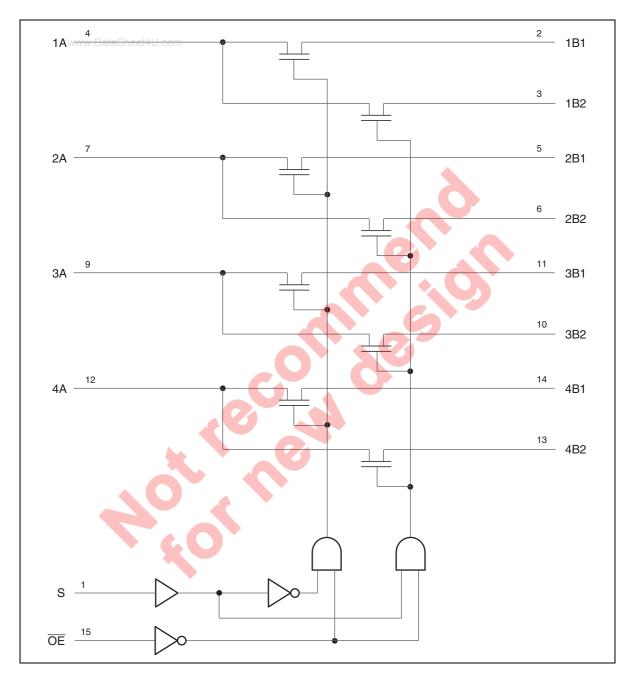
Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V _{cc}	4.0	5.5	V	
Input voltage range	Vi	0	5.5	V	
Output voltage range	V _{I/O}	0	5.5	V	
Input transition rise or fall rate	Δt / Δν	0	5	ns / V	$V_{cc} = 4.5 \text{ to } 5.5 \text{ V}$
Operating free-air temperature	Та	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

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Block Diagram



DC Electrical Characteristics

$(Ta = -40 \text{ to } 85^{\circ}\text{C})$

Item www.DataShee	¹⁴ Symbol	V _{cc} (V)	Min	Тур ⁺¹	Max	Unit	Test conditions
Clamp diode voltage	V _{IK}	4.5	—	_	-1.2	V	I _{IN} = -18 mA
Input voltage	V _{IH}	4.0 to 5.5	2.0	_	_	V	
	V	4.0 to 5.5	_	—	0.8		
On-state switch resistance ^{*2}	R _{on}	4.0	_	14	20	Ω	$V_{\rm IN} = 2.4 \text{ V},$ $I_{\rm IN} = 15 \text{ mA}$ Typ at $V_{\rm cc} = 4.0 \text{ V}$
		4.5	_	5	7		$V_{IN} = 0 V,$ $I_{IN} = 64 \text{ mA}$
		4.5	_	5	7		$V_{\rm IN} = 0 V,$ $I_{\rm IN} = 30 \text{ mA}$
		4.5	_	10	15		V _{IN} = 2.4 V, I _{IN} = 15 mA
Input current	I _{IN}	0 to 5.5		-	±1.0	μA	V _{IN} = 5.5 V or GND
Off-state leakage current	I _{oz}	5.5	-	7	±1.0	μA	$0 \le A, B \le V_{cc}$
Quiescent supply current	I _{cc}	5.5	5	-	3	μA	$V_{IN} = V_{CC}$ or GND, $I_{O} = 0 \text{ mA}$
Increase in I _{cc} per input ^{'3}	ΔI_{cc}	5.5		<u>_</u> C	2.5	mA	One input at 3.4 V, other inputs at V _{cc} or GND

Notes: For condition shown as Min or Max use the appropriate values under recommended operating conditions.

1. All typical values are at $V_{cc} = 5 V$ (unless otherwise noted), Ta = 25°C.

2. Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lower voltage of the two (A or B) terminals.

3. This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{cc} or GND.

Capacitance

 $(Ta = 25^{\circ}C)$

Item		Symbol	V_{cc} (V)	Min	Тур	Max	Unit	Test conditions
Control input capacitance		C _{IN}	5.0	_	3.5		pF	$V_{IN} = 0 \text{ or } 3 \text{ V}$
Input / output	A port	$\boldsymbol{C}_{\text{I/O (OFF)}}$	5.0	_	9		pF	$V_{o} = 0 \text{ or } 3 \text{ V}$
capacitance	B port	_	5.0	_	5	_		$\overline{OE} = V_{cc}$

Note: This parameter is determined by device characterization is not production tested.

Switching Characteristics

 $(Ta = -40 \text{ to } 85^{\circ}\text{C})$

www.DataSheet4U.com $V_{cc} = 4.0 \ V$ •

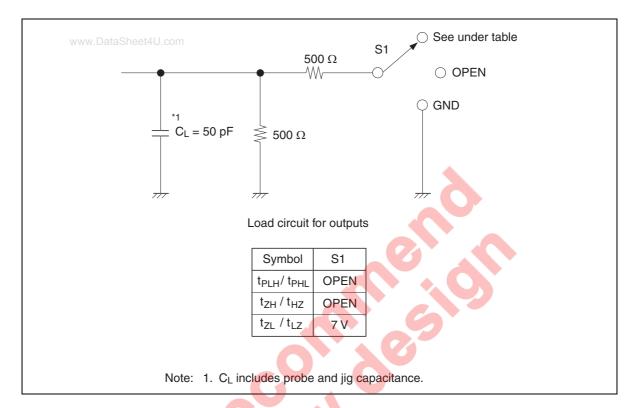
Item	Symbol	Min	Max	Unit	Test conditions	FROM (Input)	TO (Output)
Propagation delay time ^{*1}	t _{PLH} t _{PHL}		0.35	ns	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	A or B	B or A
Propagation delay time	t _{PLH} t _{PHL}		5.5	ns	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	S	A
Enable time	t _{zH}		5.7	ns	C _L = 50 pF	S	В
	t_{zL}	_	5.6		$R_{L} = 500 \Omega$	ŌE	A or B
Disable time	t _{HZ}		5.2	ns	C _L = 50 pF	S	В
			5.5		$R_{L} = 500 \Omega$	OE	A or B
	t _{LZ}		5.2	_		S	В
		_	6.4			OE	A or B
• $V_{cc} = 5.0 \pm 0.5 V$	7					EPOM	10

$V_{cc} = 5.0 \pm 0.5 \text{ V}$

Item	Symbol	Min	Max	Unit	Test conditions	FROM (Input)	TO (Output)
Propagation delay time	t _{plh} t _{phL}	0	0.25	ns	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	A or B	B or A
Propagation delay time	t _{plh} t _{phL}	1.6	5.0	ns	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	S	A
Enable time	t _{zH}	1.6	5.2	ns	$C_{L} = 50 \text{ pF}$	S	В
	t _{zL}	1.8	5.1	_	$R_{L} = 500 \Omega$	OE	A or B
Disable time	t _{HZ}	1.0	5.0	ns	$C_{L} = 50 \text{ pF}$	S	В
		2.2	5.5	_	R_{L} = 500 Ω	OE	A or B
	t _{LZ}	1.0	5.0	_		S	В
		2.2	6.8			OE	A or B

1. The propagation delay is the calculated RC time constant of the typical on-state resistance of the Note: switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

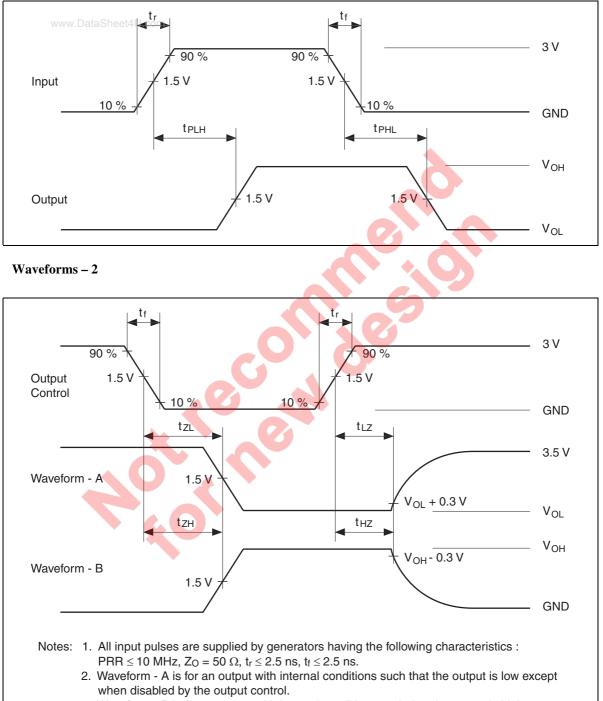
Test Circuit



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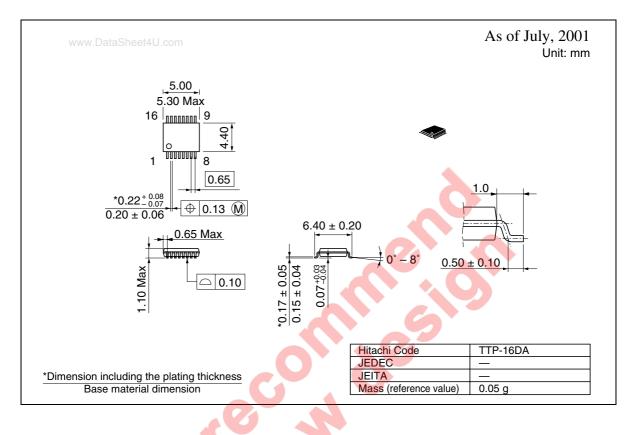
Waveforms – 1



- 3. Waveform B is for an output with internal conditions such that the output is high except when disabled by the output control.
- 4. The output are measured one at a time with one transition per measurement.

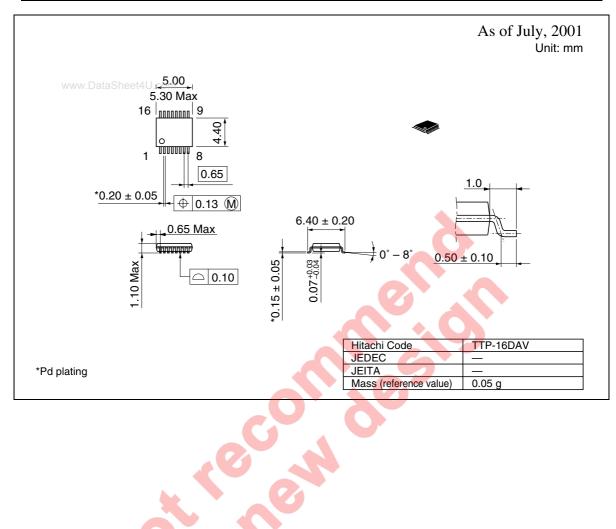
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Package Dimensions



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